Declaration and Power of Attorney United States Patent Application

Patents and Design Patents
Sole & Joint Inventors
Convention & Non-convention
PCT & Non-PCT
This form cannot be amended, nilected
or changed after it is signed
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understand the Envilsh thousa

UNITED STATES (Form BDW 1)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (If only one name to litted below) or an original, first and joint inventor (If only one name to litted below) or an original, first and joint inventor (If only one name to litted below) or an original, first and joint inventor (If only one name to litted below) or an original, first and joint inventor (If plantal names are listed below) on the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD OF CUTTING CSP SUBSTRATES

(check one) 8 is attached hereto.

was filed on ______ as U.S. Application Serial No._____ and (If applicable)

referred to above.

Fiscknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal

Frickinowledge the duty to discusse morniation which is material to the examination of this application in accordance with Inte 37, Code of Federal Regulations, \$1.56(a).

Thereby claim foreign priority benefits under Title 35, United States Code, \$119 of any foreign and PCT application(s) for patent or inventor's certificate ligid in this Declaration and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application of which priority is claimed:

Foreign/PCT Application No.	Country	Filing Date	Prinrity Claimed? (yes/no)
Patent Application No. 2000 - 3533	Japan	January 12, 2000	Yes

Febrerly claim the benefit under Title 35, United States Code, \$120 of any United States application(s) and PCT International Application(s) fated in this Bigelarration and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the minumer provided by the first paragraph of Title 35, United States Code, \$112, in exhaustedge the duty to disclose undertail information as defined in Title 37, Code of Federal Regulations, \$1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing This of this application:

U.S. Application No.	Filing Date	Status (patented/pending/abandoned?)

I hereby appoint the following attorneys to protecute this application and to transact all business in the Patent and Transmark Office connected therewith: Joseph A. DeGrandi (17446), Robert G. Weishert (268913), Richard A. Nakuch (32263), Remard A. Menuy (22001), Richard A. Nakuch (32263), Remard A. Menuy (22001), Richard A. Menuy (23011), Richard A. Menuy (24001), Richard A. Me

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I herdy declare that all statements made herein of my own knowledge are true and that all statements made in information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by flue or impresumment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any putent sissed deteroor.

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Signature: TAKAHIRO SATTO	Date: December 18, 2000
Full name of second joint inventor, if any: Residence (city, state, country): Post office address:	Citizenship:
Signature:	Date: